# MOTORY TECHNOLOGY

# Move Up to the Next Generation



Enhanced Performance, Improved Thermal Ratings for Increased Power

Used in - 3G Base Stations

Increased Gain, Linearity, Power Density and Reliability

Used in - W-CDMA & UMTS Base Stations, Multi Carrier PCS CDMA Amplifiers and GSM-EDGE



Transistion to State of the Art Wafer Processing Increases Efficiency and Allows Operation Above 2 GHz

Used in - PCS CDMA Base Stations, DAB and 1800 MHz GSM Base Stations



Process Refinement Increases Gain, Linearity and Power Density

Used in - Paging Base Stations, Multi Carrier Linear Amplifiers and GSM Handsets



RF LDMOS Pushes Silicon FET Technology to 1 GHz

Used in - Cellular Base Stations, Land Mobile Radios & Base Stations and TV Transmitters IN 2000 AND BEYOND

MRF376, MRF9085, MRF9180, MRF9045, MRF9045M, MRF19045, MRF19085, MRF19125, MRF21180, MRF21125



MRF18060A/B, MRF18090A/B, MRF19030, MRF19060, MRF19090, MRF19120 MRF21030, MRF21060, MRF21090, MRF21120

MRF9482T1





#### BEGINNING 1998

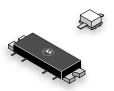
MRF1511T1, MRF1513T1, MRF1518T1, MRF1517T1, MRF372, MHVIC910L, MHL19336, MRF6522-70, MHL19338, MHL21336

MRF286 MRF9382T1

MHL9838, MHL9318, MHW1810

MRF281S, MRF282S MHL9236

MRF284



#### BEGINNING 1996

MRF374

MRF373

Mid-Voltage Discretes

MRF6522-5, MRF6522-10 MRF187

MRF186

MRF184

Low-Voltage Discretes



#### BEGINNING 1994

MRF181S, MRF181Z

MRF185

MRF182, MRF183

**LDMOS Power Modules** 



## EXCITING NEW BREAKTHROUGHS IN RF LDMOS TECHNOLOGY

New Motorola RF LDMOS Devices Set Benchmark for 3G, 2.2 GHz Market

TEMPE, ARIZONA, FEBRUARY 23, 2000... The MRF21125 is the highest single-ended device (125 watts) and the MRF21180 is the highest push-pull device (160 watts) now available in the 2.2 GHz band for W-CDMA applications.

## New Motorola RF LDMOS Family Optimized for GSM Base Station Applications

TEMPE, ARIZONA,
NOVEMBER 15, 1999...
The introduction of a GSM specific family of products continues
Motorola's strategy to penetrate its
HV4 generation RF LDMOS into all major markets. The first product to be unveiled in the MRF18000 line-up, the MRF18060A/MRF18060AS, is a 60-watt device operating up to 2.0 GHz.

## Motorola Receives JEDEC Approval on Two RF Power Plastic Packages for Wireless Applications

TEMPE, ARIZONA,
OCTOBER 16, 1999...
TO-270 and TO-272 are the first
JEDEC approved plastic packages
for high power RF LDMOS discre.

JEDEC approved plastic packages for high power RF LDMOS discrete transistors capable of handling up to 65 watts.



## **Motorola RF LDMOS Product Family**

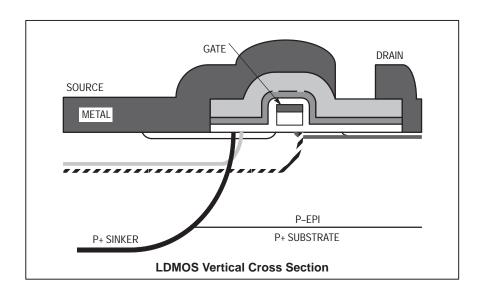
As digital standards increasingly dominate the wireless communication market, Motorola's RF LDMOS technology has become the industry's technology of choice due to its superior linearity, gain and efficiency characteristics. Motorola's LDMOS technology is used in making high power, high frequency RF amplifier designs simpler, easier, and more cost effective, thus enabling our customers to compete in today's competitive wireless markets.

We are enhancing our RF portfolio by combining world leadership in submicron VLSI MOS technology with high volume manufacturing. The result: An even wider breadth of RF products, including discrete medium and high power devices, power modules, ICs and Class A, ultra—linear amplifiers.

Motorola continues to develop and improve its patented RF LDMOS design and has recently extended performance on new 4th generation RF LDMOS products. The newest product introductions incorporate the latest process improvements. Take advantage of the increased ease of use and improved performance as highlighted below.

#### Advantages of RF LDMOS transistors for new designs:

Higher Gain	Reliable processing creates higher performance
Higher Efficiency	Increased power density allows for higher power
Better Thermal Performance	Higher average power is achieved
Higher Reliability	. Double layer metal increases MTBF
• Ease of Use	Addition of die level ESD protection diodes decreases handling concerns



# Access LDMOS Models, Test Fixtures and Reference Designs On–line!

Visit our web pages for distribution of our NEW electro-thermal models for RF LDMOS transistors.

The url is: http://www.motorola.com/semiconductors/rf/models/

The new Motorola Electro Thermal (MET) model for RF LDMOS transistors is a nonlinear model that for the first time examines both electrical and thermal phenomena and can account for dynamic self–heating effects of device performance. It is specifically tailored to model high power RF LDMOS transistors used in base station, HDTV digital broadcast, and land mobile radio applications. Implemented in the Agilent–EEsof's<sup>®</sup> Libra<sup>®</sup> (V6.1 and V6.6) and Advanced Design System (ADS V1.3) harmonic balance simulators, the MET LDMOS model is capable of performing small–signal, large–signal, harmonic–balance, noise and transient simulations. Because of its ability to simulate self–heating effects, the MET model is more accurate than existing models, enabling circuit designers to predict prototype performance more accurately and reduce cycle time.

The model is available as a compiled code for all major computer platforms including Microsoft® Windows® 95, 98 and Windows NT® 4.0, Solaris® 2.6 and HP–UX® 10.2. The object code can easily be linked with Agilent–EEsof's Libra and ADS harmonic balance simulators.

Subscribe to our LDMOS Models mail list to get the latest news on the availability of newly released RF LDMOS Transistor Models. To subscribe, just fill out the RF LDMOS Transistor Model Subscription form on–line at http://www.motorola.com/semiconductors/rf/models/ and you will receive notification of new models as they are posted.

#### AND, visit our web pages for distribution of Test Fixtures and Reference Designs.

The url is: http://www.motorola.com/semiconductors/rf/designtds/designtd.html

The Test Fixture library contains application specific solutions for select Motorola parts. Access the Test Fixture library to determine which test fixture is most suitable for your application.

The Reference Design library contains easy—to—copy, fully functional amplifier designs. They consist of "no tune" distributed element matching circuits designed to be as small as possible, include temperature compensated bias circuitry, and are designed to be used as "building blocks" for our customers.

Test fixtures and functional Reference Design test units can be purchased for a nominal fee. Contact your local Motorola Distributor for additional information.

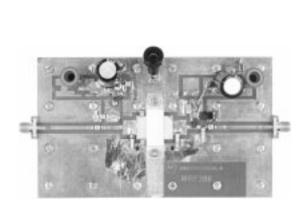


Figure 1. Test Fixture Example



Figure 2. Reference Design Example

All brand names and product names appearing in this document are registered trademarks or trademarks of their respective owners.

## **RF High Power Transistors**

Our LDMOS technology is ideally suited for RF power amplifier applications. Several families of products have been targeted for specific markets including VHF and UHF portable, 900 MHz linear cellular, GSM, TDMA and CDMA, Digital Television, GSM–Edge, PCS, UMTS, and W–CDMA.

Thanks to unique LDMOS characteristics, these parts offer superior thermal performance. This is due to the simplified package design, which offers excellent Class AB intermodulation performance under medium peak—to—average ratios which makes for a fine device choice for advanced digital modulations formats or high gain applications.

## **RF LDMOS High Power Transistors**

#### Mobile - To 520 MHz

Device	P <sub>out</sub> Output Power Watts	Gain (Typ)/Freq. dB/MHz	η Eff. (Typ) %	₀C\M θ <b>ገ</b> C	Package/Style				
VHF & UHF, V <sub>DD</sub> = 7.5 Volts, Class AB, Land Mobile Radio									
MRF1511T1(18f,46a) MRF1517T1(18f,46a)	8 8	11.5/175 11/520	55 55	2.0 2.0	466/1 466/1				
VHF & UHF, V <sub>DD</sub> = 7.5/12.5 Volts, Class AB, Land Mobile Radio									
MRF1513T1 <sup>(18f,46a)</sup>	3	11/520	55	2.0	466/1				
VHF & UHF, V <sub>DD</sub> = 12.5 Volts, Class AB, Land Mobile Radio									
MRF1518T1 <sup>(18f,46a)</sup>	8	11/520	55	2.0	466/1				

#### Broadcast - To 1.0 GHz - Lateral MOSFETs

Device 470 – 1000 MHz, V <sub>D</sub>	P <sub>out</sub> Output Power Watts D = 28 Volts, Class	Gain (Typ)/Freq. dB/MHz s AB	η Eff. (Typ) %	<sub>θ</sub> JC ∘C/W	IMD dBc	Package/Style			
MRF373 MRF373S MRF372 <sup>(9)</sup> MRF374	60 60 180 PEP 100 PEP	14.7/860 14.7/860 14.0/860 13.5/860	54 54 35 36	1.0 0.75 0.4 0.5	  _30 _31	360B/1 360C/1 375B/2 375F/2			
470 – 1000 MHz, V <sub>DD</sub> = 50 Volts, Class AB									
MRF376 <sup>(9)</sup>	240	14/860	55	0.3	_	375B/2			

#### Cellular - To 1.0 GHz - Lateral MOSFETs

Device	Pout Output Power Watts	Gain (Typ)/Freq. dB/MHz	η Eff. (Typ) %	<sub>θ</sub> JC ∘C/W	Package/Style					
800 – 1.0 GHz, V <sub>DD</sub> = 26 Volts, Class AB										
MRF6522-5R1(18a,46a)	5 CW	18/960	53	15	458A/1					
MRF6522-10R1(18a,46a)	10 CW	17.5/960	55	6.0	458A/1					
MRF6522-70 <sup>(18i)</sup> ★	70 CW	16/921-960	58	1.1	465D/1					
MRF187	85 PEP	13/880	33	0.7	465/1					
MRF187S	85 PEP	13/880	33	0.7	465A/1					
MRF9085 <sup>(46a)</sup>	85 PEP	17/880	38	0.7	465/1					
MRF9085S(46a)	85 PEP	17/880	38	0.7	465A/1					
MRF9180 <sup>(46a)</sup>	180 PEP	17/880	38	0.4	375D/2					

Cellular – To 1.0 GHz – Lateral MOSFETs (continued)

Device	P <sub>out</sub> Output Power Watts	Gain (Typ)/Freq. dB/MHz	η Eff. (Typ) %	∘C\M θ <b>ገ</b> C	Package/Style				
800 – 1.0 GHz, V <sub>DD</sub> = 28 Volts, Class AB									
MRF181SR1(18a,46a)	8 PEP	17/945	35	3.6	458/1				
MRF181ZR1(18a,46a)	8 PEP	17/945	35	3.6	458A/1				
MRF182	30 CW	14/945	58	1.75	360B/1				
MRF182S(18a)	30 CW	14/945	58	1.75	360C/1				
MRF183	45 PEP	13.5/945	38	1.5	360B/1				
MRF183S(18a)	45 PEP	13.5/945	38	1.5	360C/1				
MRF9045(46a)	45 PEP	18/945	42	1.3	360B/1				
MRF9045S(46a)	45 PEP	18/945	42	1.3	360C/1				
MRF9045M <sup>(46a)</sup>	45 PEP	16/945	40	TBD	1265/-				
MRF184	60 CW	13.5/945	60	1.1	360B/1				
MRF184S(18a)	60 CW	13.5/945	60	1.1	360C/1				
MRF185 <sup>(3)</sup>	85 CW	14/960	53	0.7	375B/2				
MRF186 <sup>(3)</sup>	120 PEP	12/945	35	0.6	375B/2				

PCS and 3G - To 2.1	GHz – Lateral I	MOSFETS	3							
Device	Pout Output Power Watts	Class	Gain (Typ)/Freq. dB/MHz	η Eff. (Typ) %	∘C/W <sub>θ</sub> JC	Package/Style				
1805 – 1990 MHz, V <sub>DD</sub> = 26 Volts (GSM1800, GSM1900 and PCS TDMA)										
MRF18060A★	60 CW	AB	13/1805–1880	45	0.97	465/1				
MRF18060AS★	60 CW	AB	13/1805–1880	45	0.97	465A/1				
MRF18060B★	60 CW	AB	13/1930-1990	45	0.97	465/1				
MRF18060BS★	60 CW	AB	13/1930-1990	45	0.97	465A/1				
MRF18090A★	90 CW	AB	13.5/1805-1880	52	0.7	465B/1				
MRF18090AS★	90 CW	AB	13.5/1805-1880	52	0.7	465C/1				
MRF18090B★	90 CW	AB	13.5/1930–1990	45	0.7	465B/1				
MRF18090BS★	90 CW	AB	13.5/1930–1990	45	0.7	465C/1				
1.9 GHz, V <sub>DD</sub> = 26 V	olts (PCS CDM	<b>A)</b>								
MRF19030(46a)	30 PEP	AB	13/1990	36	1.2	465E/1				
MRF19030S(46a)	30 PEP	AB	13/1990	36	1.2	465F/1				
MRF19045(46a)	45 PEP	AB	14/1990	37	0.84	465E/1				
MRF19045S <sup>(46a)</sup>	45 PEP	AB	14/1990	37	0.84	465F/1				
MRF19060★	60 PEP	AB	12.5/1990	36	0.97	465/1				
MRF19060S★	60 PEP	AB	12.5/1990	36	0.97	465A/1				
MRF19090★	90 PEP	AB	11.5/1990	35	0.65	465B/1				
MRF19090S(18a)★	90 PEP	AB	11.5/1990	35	0.65	465C/1				
MRF19085 <sup>(46a)</sup>	90 PEP	AB	12.5/1990	37	0.64	465/1				
MRF19085S(46a)	90 PEP	AB	12.5/1990	37	0.64	465A/1				
MRF19120(3,46a)	120 PEP	AB	11.8/1990	34.5	0.45	375D/2				
MRF19120S(3,46a)	120 PEP	AB	11.8/1990	34.5	0.45	375E/2				
MRF19125(46a)	125 PEP	AB	12.5/1990	35	0.53	465B/1				
MRF19125S <sup>(46a)</sup>	125 PEP	AB	12.5/1990	35	0.53	465C/1				
2.0 GHz, V <sub>DD</sub> = 26 V	olts		•							
MRF281SR1(18a,46a)	4 PEP	A, AB	13.6/2000	41	8.75	458/1				
MRF281ZR1(18a,46a)	4 PEP	A, AB	13.6/2000	41	8.75	458A/1				
MRF282SR1(18a,46a)	10 PEP	A, AB	12.5/2000	34	2.9	458/1				
MRF282ZR1(18a,46a)	10 PEP	A, AB	12.5/2000	34	2.9	458A/1				
MRF284	30 PEP	A, AB	10.5/2000	35	2.0	360B/1				
MRF284SR1(18a)	30 PEP	A, AB	10.5/2000	35	2.0	360C/1				
MRF286(46a)	60 PEP	A, AB	10.5/2000	31	0.73	465/1				
MRF286S(46a)	60 PEP	A, AB	10.5/2000	31	0.73	465A/1				

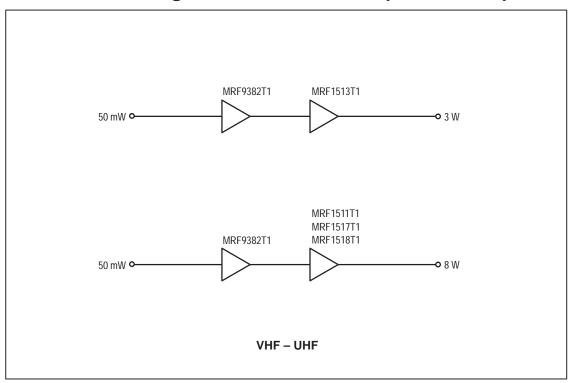
PCS and 3G - To 2.1 GHz - Lateral MOSFETs (continued)

2.1 GHz, V<sub>DD</sub> = 28 Volts (W-CDMA, UMTS)

Device	P <sub>out</sub> Output Power Watts	Class	Gain (Typ)/Freq. dB/MHz	η Eff. (Typ) %	₀c\M <sub>θ</sub> ʔC	Package/Style
MRF21030(46a)	30 PEP	AB	13.5/2170	33	1.2	465E/1
MRF21030S(46a)	30 PEP	AB	13.5/2170	33	1.2	465F/1
MRF21060★	60 PEP	AB	12.5/2170	34	1.02	465/1
MRF21060S★	60 PEP	AB	12.5/2170	34	1.02	465A/1
MRF21090 <sup>(46a)</sup>	90 PEP	AB	11.7/2170	33	0.65	465B/1
MRF21090S(46a)	90 PEP	AB	11.7/2170	33	0.65	465C/1
MRF21120(3,46a)	120 PEP	AB	11.3/2170	35	0.45	375D/2
MRF21120S(3,46a)	120 PEP	AB	11.3/2170	35	0.45	375E/2
MRF21125 <sup>(26)</sup> ★	125 PEP	AB	12/2170	34	0.53	465B/1
MRF21125S <sup>(26)</sup> ★	125 PEP	AB	12/2170	34	0.53	465C/1
MRF21180 <sup>(3,46a)</sup>	160 PEP	AB	11.3/2170	33	0.39	375D/2
MRF21180S(3,46a)	160 PEP	AB	11.3/2170	33	0.39	375E/2

<sup>(3)</sup>Internal Impedance Matched Push-Pull Transistors

## RF LDMOS High Power Transistor Amplifier Line-ups



<sup>(9)</sup>In Development

<sup>(18)</sup> Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units;

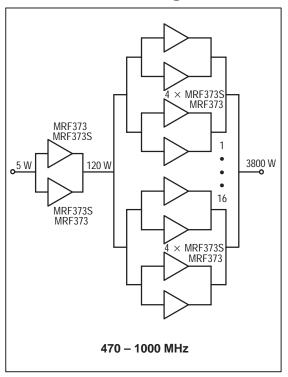
d) T3 = 10,000 units; e) R2 = 1,500 units; f) T1 = 1,000 units; g) R2 = 4,000 units; h) R1 = 1,000 units; i) R3 = 250 units.

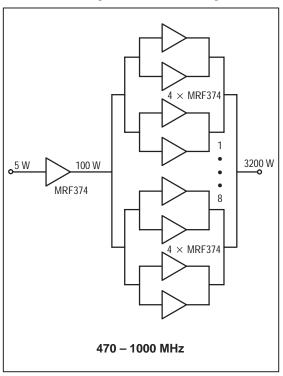
<sup>(26)</sup>W-CDMA = 20 W P<sub>OUt</sub>, 13 dB Gain, 18% Efficiency, 2.1125–2.1675 GHz.

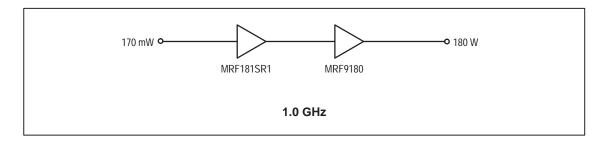
<sup>(46)</sup>To be introduced: a) 1Q00; b) 2Q00; c) 3Q00

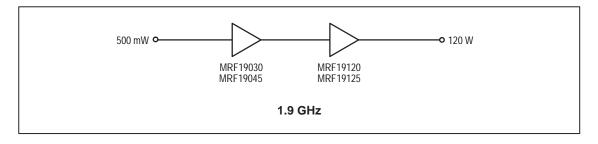
<sup>★</sup> New Product

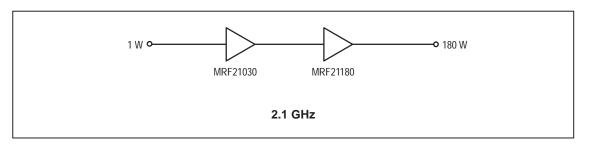
## **RF LDMOS High Power Transistor Amplifier Line-ups**



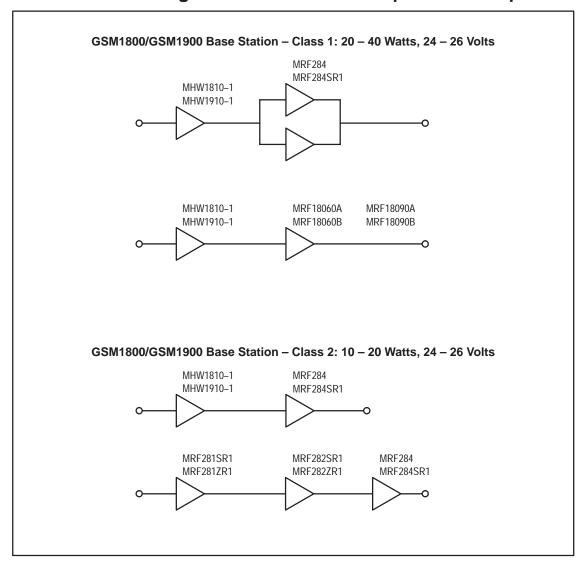






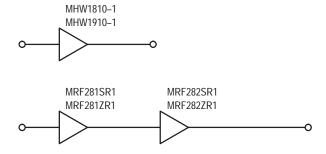


## **RF LDMOS High Power Transistor Amplifier Line-ups**



## RF LDMOS High Power Transistor Amplifier Line-ups

### GSM1800/GSM1900 Base Station - Class 3: 5 - 10 Watts, 24 - 26 Volts Microcell



#### GSM900 Base Station - Class 4: 40 - 80 Watts, 24 - 26 Volts



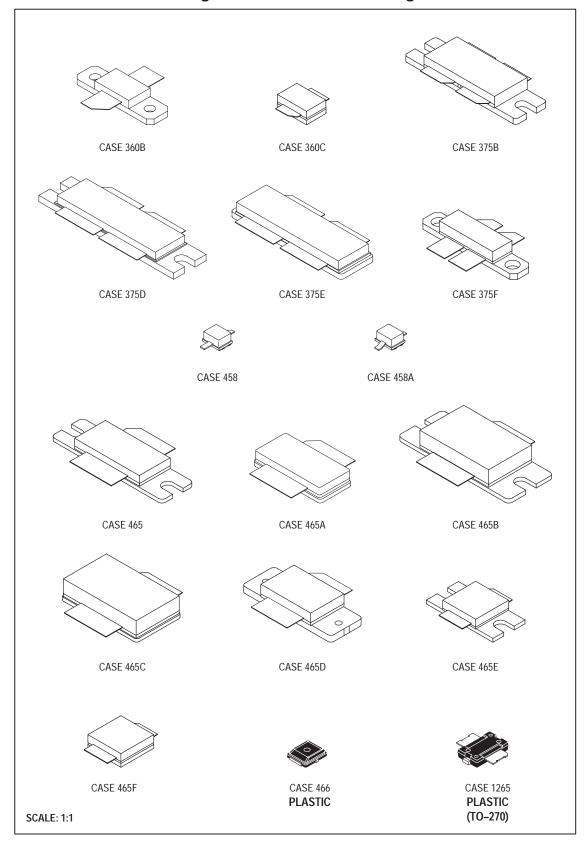
#### GSM900 Base Station - Class 5: 20 - 40 Watts, 24 - 26 Volts



GSM900 Base Station - Class 7: 5 - 10 Watts, 24 - 26 Volts



## **RF High Power Transistor Packages**



# **RF LDMOS for Portable Applications**

Motorola's newly introduced family of RF LDMOS medium power discretes is ideally suited for battery operated portable transmitters in the 4.8 and 6 V nominal battery voltage range. In addition, they make excellent driver devices in power amplifiers. These surface mount devices are conducive to cost effective volume manufacturing and are available in tape and reel packaging.

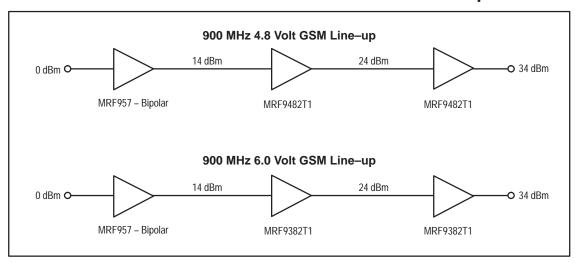
Because of inherent LDMOS characteristics, their small size, high gain, ruggedness, voltage-controlled gates and single supply operation allow usage in almost any portable application such as analog cellular, GSM cellular, PCS, cordless phones, RF modems, cable modems and talkback pagers.

## **RF LDMOS Medium Power Transistors**

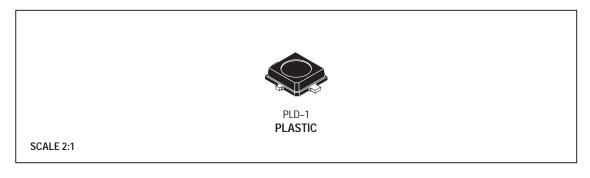
Device	Freq. MHz	V <sub>DD</sub> V	Typical Output Power dBm	Typical Drain Eff. %	Typical Gain dB	Semiconductor Technology	Case No./ Package
MRF9382T1 (18f,46a)	900	6.0	36.5	65	10.5	LDMOS	449/PLD-1
MRF9482T1 (18f,46a)	900	4.8	36.0	65	10	LDMOS	449/PLD-1

<sup>(18)</sup> Tape and Reel Packaging Option Available by adding suffix: a) R1 = 500 units; b) R2 = 2,500 units; c) T1 = 3,000 units; d) T3 = 10,000 units; e) R2 = 1,500 units; f) T1 = 1,000 units; g) R2 = 4,000 units; h) R1 = 1,000 units; i) R3 = 250 units. (46) To be introduced: a) 1,000; b) 2,000; c) 3,000

## **RF LDMOS Medium Power Transistor Line-ups**



## **RF Medium Power Transistor Plastic Package**



# **RF Amplifier Modules**

Utilizing Motorola's leadership in the integration of LDMOS, new families of smaller, more efficient, and cost effective amplifier modules are available. LDMOS amplifiers provides high stage gain and good linear performance when used in cellular and other wireless applications. They are single supply, fully-matched designs using a silicon based technology.

Current designs cover GSM, CDMA, W-CDMA, TDMA and Analog applications.

## **RF LDMOS Amplifier Modules/ICs**

#### **Base Stations**

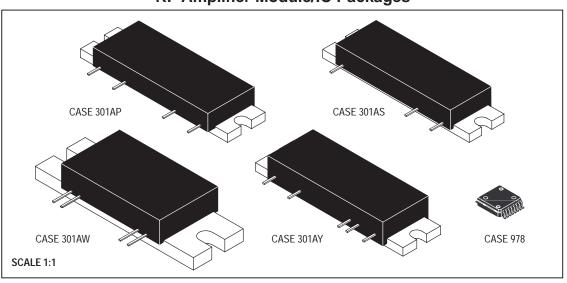
Device	P <sub>out</sub> Output Power Watts	P <sub>in</sub> Input Power Watts	f Frequency MHz	Gain (Min) dB	Supply Voltage Volts	Package/Style					
880–960 MHz (for	880-960 MHz (for GSM900) — Class AB										
MHVIC910L (46b)	10	0.050	921–960	22	26	978/–					
1805–1880 MHz (f	or GSM180	0) — Class <i>A</i>	<b>λ</b> B								
MHW1810-1 MHW1810-2	10 10	0.040 0.008	1805–1880 1805–1880	24 32	26 26	301AW/1 301AW/1					
1930–1990 MHz (for GSM1900) — Class AB											
MHW1910-1	10	0.040	1930–1990	24	26	301AW/1					

#### **Base Station Drivers**

Device	Frequency Band MHz	V <sub>DD</sub> (Nom.) Volts	I <sub>DD</sub> (Nom.) mA	Gain (Nom.) dB	Gain Flatness (Typ) ±dB	P <sub>1dB</sub> (Typ) dBm	3rd Order Intercept (Typ) dBm	NF (Typ) dB	Case/ Style	
Ultra-Linear (fo	Ultra-Linear (for CDMA, W-CDMA, TDMA, Analog) - Class A - Lateral MOSFETs									
MHL9838★	800-925	28	770	31	.1	39	50	3.7	301AP/1	
MHL9236	800-960	26	550	30.5	.1	34	47	3.5	301AP/1	
MHL9236M	800-960	26	550	30.5	.1	34	47	3.5	301AP/2	
MHL9318★	860-900	28	500	17.5	.1	35.5	49	3.0	301AS/1	
MHL19338 ★	1900-2000	28	500	30	.1	36	46	4.2	301AP/1	
MHL19936 (46b)	1900-2000	28	1400	30	.2	41	51	4.2	301AY/1	
MHL21336 ★	2110-2170	26	500	31	.15	35	45	4.5	301AP/1	

<sup>(46)</sup>To be introduced: a) 1Q00; b) 2Q00; c) 3Q00

## RF Amplifier Module/IC Packages



<sup>★</sup> New Product

# See the technical journals referenced below for additional published articles on RF LDMOS.

Anderson, George, "Moto Aims FETs at UHF," Electronic Engineering Times, September 2, 1996, p. 96.

Boulay, Jean-Marie, Mark Burdick, Greg Kinnetz and Jean-Jacques Bouny, "Splitters/Combiners Team with RF LDMOS in UMTS AMP," *Microwaves & RF*, July 1999, p. 80–92.

Bouny, Jean–Jacques, "Advantages of LDMOS in High Power Linear Amplification," *Microwave Engineering Europe*, April 1996, p. 37–40. (Order as AR614/D from the Motorola Literature Center.)

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